

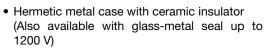
Phase Control Thyristors (Stud Version), 200 A



PRODUCT SUMMARY				
I _{T(AV)}	200 A			
V _{DRM} /V _{RRM}	400 V, 800 V, 1200 V, 1600 V, 2000 V			
V _{TM}	1.75 V			
I _{GT}	150 mA			
T _J	-40 °C to 125 °C			
Package	TO-209AB (TO-93)			
Diode variation	Single SCR			

FEATURES

- · Center amplifying gate
- International standard case TO-209AB (TO-93)





- Compression bonded encapsulation for heavy duty operations such as severe thermal cycling
- · Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

- DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS					
PARAMETER	TEST CONDITIONS	VALUES	UNITS		
1		200	A		
I _{T(AV)}	T _C	85	°C		
I _{T(RMS)}		314	Α		
1	50 Hz	5000	^		
ITSM	60 Hz	5230	A		
l ² t	50 Hz	125	kA ² s		
1-1	60 Hz	114	KA-S		
V _{DRM} /V _{RRM}		400 to 2000	V		
t _q	Typical	100	μs		
T _J		-40 to 125	°C		

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS							
TYPE NUMBER	VOLTAGE CODE	V _{DRM} /V _{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	$\begin{aligned} I_{DRM}/I_{RRM} & \text{MAXIMUM} \\ \text{AT T}_{J} &= T_{J} & \text{MAXIMUM} \\ & \text{mA} \end{aligned}$			
	04	400	500				
	08	800	900				
VS-ST180S	12	1200	1300	30			
	16	1600	1700				
	20	2000	2100				



ABSOLUTE MAXIMUM RATINGS	3					
PARAMETER	SYMBOL		TEST CONDITIONS			UNITS
Maximum average on-state current	L	190° condu	ction, half sine	NOVO	200	Α
at case temperature	I _{T(AV)}	100 Condu	iction, nan sine	wave	85	°C
Maximum RMS on-state current	I _{T(RMS)}	DC at 76 °C	case temperat	ure	314	
		t = 10 ms	No voltage		5000	
Maximum peak, one-cycle		t = 8.3 ms	reapplied		5230	A kA ² s
non-repetitive surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}		4200	
		t = 8.3 ms	reapplied	Sinusoidal half wave,	4400	
2.6.6.		t = 10 ms	No voltage reapplied	initial $T_J = T_J$ maximum	125	
	l ² t	t = 8.3 ms			114	
Maximum I ² t for fusing		t = 10 ms	100 % V _{RRM}		88	
		t = 8.3 ms	reapplied		81	
Maximum I ² √t for fusing	I ² √t	t = 0.1 to 10	0 ms, no voltage	reapplied	1250	kA²√s
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % x π	$x \mid_{T(AV)} < I < \pi x$	$I_{T(AV)}$), $T_J = T_J$ maximum	1.08	V
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)})$	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$			_ v
Low level value of on-state slope resistance	r _{t1}	(16.7 % x π	(16.7 % x π x $I_{T(AV)}$ < I < π x $I_{T(AV)}$), $T_J = T_J$ maximum			mΩ
High level value of on-state slope resistance	r _{t2}	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum} $ 1.			1.14	11152
Maximum on-state voltage	V_{TM}	$I_{pk} = 570 \text{ A}, T_J = 125 ^{\circ}\text{C}, t_p = 10 \text{ ms sine pulse}$			1.75	V
Maximum holding current	I _H			600	^	
Maximum (typical) latching current	ΙL	ıj=ıjmax	dinum, anode si	upply 12 v resistive load	1000 (300)	mA

SWITCHING						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum non-repetitive rate of rise of turned-on current	dl/dt	Gate drive 20 V, 20 Ω , $t_r \le 1~\mu s$ $T_J = T_J$ maximum, anode voltage $\le 80~\%~V_{DRM}$	1000	A/µs		
Typical delay time	t _d	Gate current 1 A, $dl_g/dt = 1 A/\mu s$ $V_d = 0.67 \% V_{DRM}, T_J = 25 °C$	1.0			
Typical turn-off time	t _q	$\begin{split} I_{TM} = 300 \text{ A, } T_J = T_J \text{ maximum, dl/dt} = 20 \text{ A/}\mu\text{s,} \\ V_R = 50 \text{ V, dV/dt} = 20 \text{ V/}\mu\text{s, gate 0 V 100 }\Omega, t_p = 500 \mu\text{s} \end{split}$	100	μs		

BLOCKING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum critical rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum linear to 80 % rated V_{DRM}	500	V/µs	
Maximum peak reverse and off-state leakage current	I _{RRM} , I _{DRM}	$T_J = T_J$ maximum, rated V_{DRM}/V_{RRM} applied	30	mA	



TRIGGERING						
PARAMETER	SYMBOL	_	TEST COMPLETIONS		VALUES	
PARAMETER	STINIBUL	'	EST CONDITIONS	TYP.	MAX.	UNITS
Maximum peak gate power	P _{GM}	$T_J = T_J$ maximum,	, t _p ≤ 5 ms	1	0	W
Maximum average gate power	P _{G(AV)}	$T_J = T_J$ maximum,	, f = 50 Hz, d% = 50	2	.0	VV
Maximum peak positive gate current	I _{GM}	$T_J = T_J$ maximum,	, t _p ≤ 5 ms	3	.0	Α
Maximum peak positive gate voltage	+ V _{GM}	$T_{J} = T_{J} \text{ maximum, } t_{p} \le 5 \text{ ms}$ 20 5.0		0	V	
Maximum peak negative gate voltage	- V _{GM}			5.0		V
	I _{GT}	T _J = - 40 °C	Maximum required gate trigger/ current/voltage are the lowest value which will trigger all units	180	-	mA
DC gate current required to trigger		T _J = 25 °C		90	150	
		T _J = 125 °C		40	-	
		T _J = - 40 °C		2.9	-	
DC gate voltage required to trigger	V_{GT}	T _J = 25 °C	12 V anode to cathode applied	1.8	3.0	V
		T _J = 125 °C		1.2	-	
DC gate current not to trigger	I _{GD}		Maximum gate current/voltage	10		mA
DC gate voltage not to trigger	V_{GD}	$T_J = T_J maximum$	not to trigger is the maximum value which will not trigger any unit with rated V _{DRM} anode to cathode applied	0.	25	V

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum operating junction temperature range	TJ		-40 to 125	°C		
Maximum storage temperature range	T _{Stg}		-40 to 150			
Maximum thermal resistance, junction to case	R _{thJC}	DC operation	0.105	K/W		
Maximum thermal resistance, case to heatsink	R _{thC-hs}	Mounting surface, smooth, flat and greased	0.04	IV VV		
Mounting targue + 10.0/		Non-lubricated threads	31 (275)	N·m		
Mounting torque, ± 10 %		Lubricated threads	24.5 (210)	(lbf · in)		
Approximate weight			280	g		
Case style		See dimensions - link at the end of datasheeet TO-209AB (TO-9		O-93)		

△R _{thJC} CONDUCTION							
CONDUCTION ANGLE	SINUSOIDAL CONDUCTION	RECTANGULAR CONDUCTION	TEST CONDITIONS	UNITS			
180°	0.015	0.012					
120°	0.019	0.020					
90°	0.025	0.027	$T_J = T_J$ maximum	K/W			
60°	0.036	0.037					
30°	0.060	0.060					

Note

• The table above shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

www.vishay.com

Vishay Semiconductors

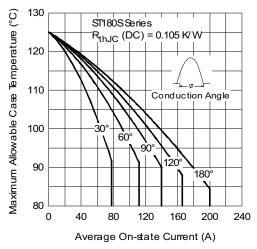


Fig. 1 - Current Ratings Characteristics

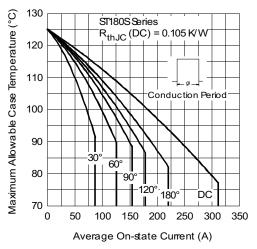


Fig. 2 - Current Ratings Characteristics

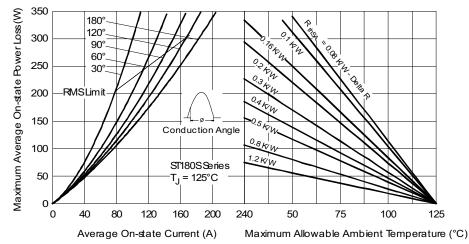


Fig. 3 - On-State Power Loss Characteristics

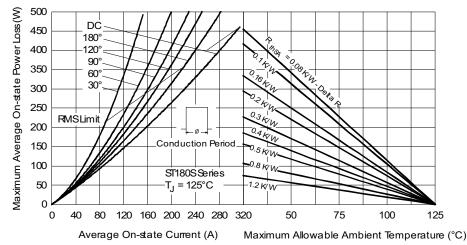


Fig. 4 - On-State Power Loss Characteristics

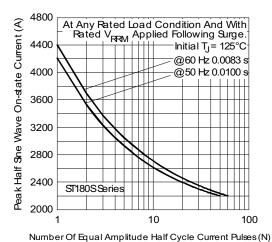


Fig. 5 - Maximum Non-Repetitive Surge Current

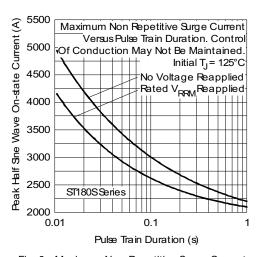


Fig. 6 - Maximum Non-Repetitive Surge Current

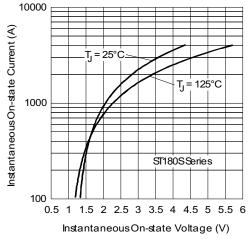


Fig. 7 - On-State Voltage Drop Characteristics

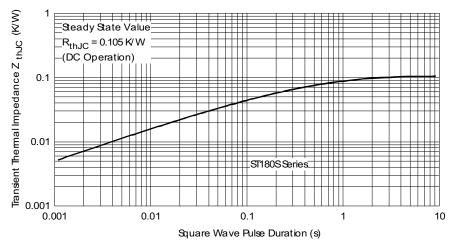


Fig. 8 - Thermal Impedance Z_{thJC} Characteristics

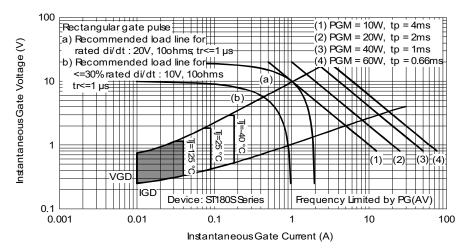
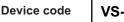
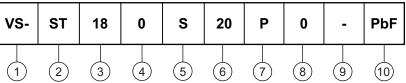


Fig. 9 - Gate Characteristics

ORDERING INFORMATION TABLE





1 - Vishay Semiconductors product

2 - Thyristor

Essential part number

4 - 0 = Converter grade

5 - S = Compression bonding stud

6 - Voltage code x 100 = V_{RRM} (see Voltage Ratings table)

| 7 | - P = Stud base 3/4"-16UNF2A threads

8 - 0 = Eyelet terminals (gate and auxiliary cathode leads)

1 = Fast-on terminals (gate and auxiliary cathode leads)

9 - V = Glass-metal seal (only up to 1200 V)

None = Ceramic housing (over 1200 V)

- None = Standard production

- PbF = Lead (Pb)-free

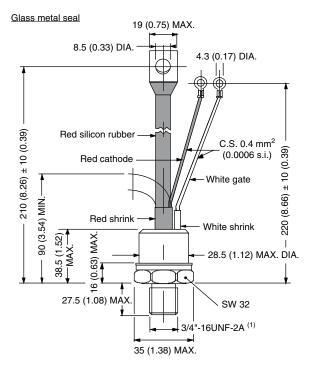
Note: For metric device M16 x 1.5 contact factory

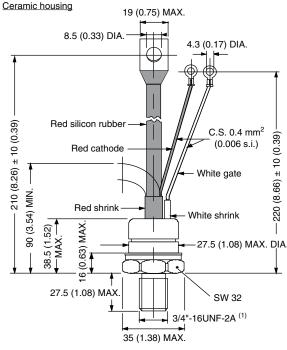
LINKS TO RELAT	TED DOCUMENTS
Dimensions	www.vishay.com/doc?95082

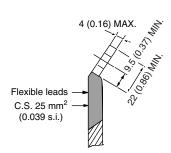


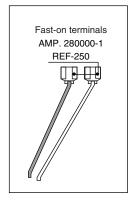
TO-209AB (TO-93)

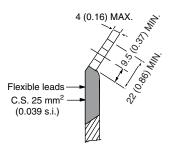
DIMENSIONS in millimeters (inches)











Note

(1) For metric device: M16 x 1.5 - length 21 (0.83) maximum

Legal Disclaimer Notice



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

© 2017 VISHAY INTERTECHNOLOGY, INC. ALL RIGHTS RESERVED